DATA SHEET

TDA3857
Quasi-split sound processor with two FM demodulators

Product specification
Supersedes data of October 1990
File under Integrated Circuits, IC02

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PHILIPS

Quasi-split sound processor with two FM demodulators — TDA3857

FEATURES

- Quasi-split sound processor for all FM standards e. g. B/G
- Reducing of spurious video signals by tracking function and AFC for the vision carrier reference circuit; (recommendable for NICAM)
- Automatic muting of the AF2 signal by the input level
- Stereo matrix correction
- Layout-compatible with TDA3856 (24 pins) and TDA3858 (32 pins).

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V_P	supply voltage (pin 19)	4.5	5	8.8	V
I_P	supply current	–	60	72	mA
$V_{i\,IF}$	IF input sensitivity (–3 dB)	–	70	100	μV
$V_{o\,AF}$	audio output signal (RMS value)	–	1	–	V
THD	total harmonic distortion	–	0.5	–	%
S/N (W)	weighted signal-to-noise ratio	–	68	–	dB

GENERAL DESCRIPTION

Symmetrical IF inputs.
Gain controlled wideband IF amplifier.
AGC generation due to peak sync.
Reference amplifier for the regeneration of the vision carrier.
Optimized limiting amplifier for AM suppression in the regenerated vision carrier signal and 90° phase shifter.
Intercarrier mixer for FM sound, output with low-pass filter.
Separate signal processing for 5.5 and 5.74 MHz intercarriers.
Wide supply voltage range, only 300 mW power dissipation at 5 V.

ORDERING INFORMATION

EXTENDED TYPE NUMBER	PACKAGE			
	PINS	PIN POSITION	MATERIAL	CODE
TDA3857	20	DIL	plastic	SOT146

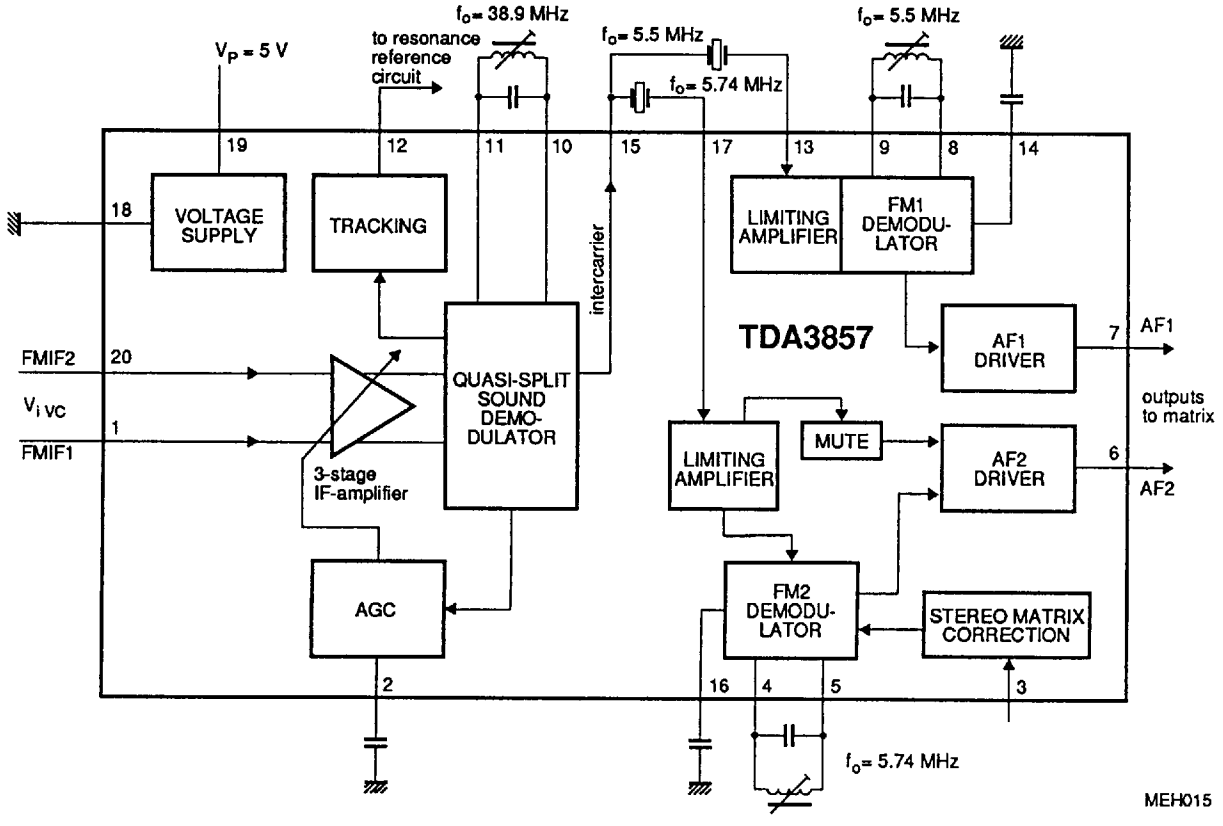


Fig.1 Block diagram (standard B/G).

PINNING

SYMBOL	PIN	DESCRIPTION
FMIF1	1	IF difference input 1 for B/G standard (38.9 MHz)
C_{AGC}	2	charge capacitor for AGC
MATR	3	input for stereo matrix correction
FM2R1	4	reference circuit for FM2 (5.74 MHz)
FM2R2	5	reference circuit for FM2 (5.74 MHz)
AF2	6	AF2 output (AF out of 5.74 MHz)
AF1	7	AF1 output (AF out of 5.5 MHz)
FM1R1	8	reference circuit for FM1 (5.5 MHz)
FM1R2	9	reference circuit for FM1 (5.5 MHz)
VC-R1	10	reference circuit for the vision carrier (38.9 MHz)
VC-R2	11	reference circuit for the vision carrier (38.9 MHz)
TRACK	12	DC output level for tracking
FM1I	13	intercarrier input for FM1 (5.5 MHz)
C_{AF1}	14	DC decoupling capacitor for FM1 demodulator (AF1)
ICO	15	intercarrier output signal (5.5/5.74 MHz)
C_{AF2}	16	DC decoupling capacitor for FM2 demodulator (AF2)
FM2I	17	intercarrier input for FM2 (5.74 MHz)
GND	18	ground (0 V)
V_P	19	+5 to +8 V supply voltage
FMIF2	20	IF difference input 2 for B/G standard (38.9 MHz)

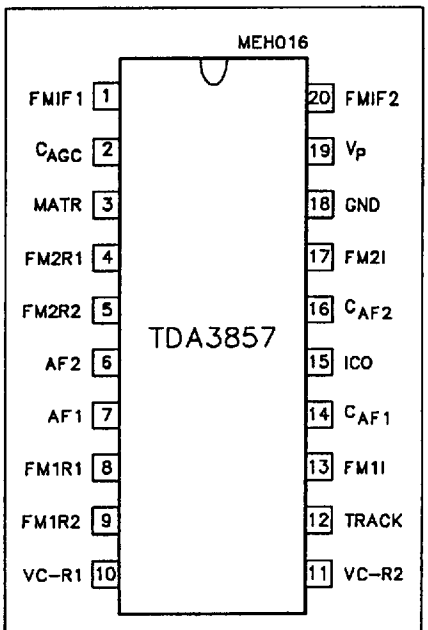


Fig.2 Pin configuration.

FUNCTIONAL DESCRIPTION

The quasi-split sound processor is suitable for all FM standards (e. g. B/G).

B/G standard

AGC detector uses peak sync level. Sound carrier SC1 (5.5 MHz) provides AF1, sound carrier SC2 (5.74 MHz) provides AF2.

Muting

With no sound carrier SC2 at pin 17, AF2 output is muted.
The mute circuit prevents false signal recognition in the stereo decoder at high IF signal levels when no second sound carrier exists (mono) and an AF signal is present in the identification signal frequency range.
With 1 mV at pin 17, under measurement conditions, AF2 is switched on (see limiting amplifier). Weak input signals at pins 1 and 20 generate noise at pin 17, which is present in the intercarrier signal and passes through the 5.74 MHz filter. Noise at pin 17 inhibits muting. No misinterpretation due to white noise occurs in the stereo decoder, when non-correlated noise masks the identification signal frequencies, which may be present in sustained tone signals. The stereo decoder remains switched to mono.

Sound carrier notch filter for an improved intercarrier buzz

The series capacitor C_S in the 38.9 MHz resonant circuit provides a notch at the sound carrier frequency in order to provide more attenuation for the sound carrier in the vision carrier reference channel. The ratio of parallel/series capacitor depends on the ratio of VC/SC frequency and has to be adapted to other TV transmission standards if necessary, according to the formula
$C_S = C_P (fvc/fsc)^2 - C_P$.
The result is an improved intercarrier buzz (up to 10 dB improvement in sound channel 2 with 250 kHz video modulation for B/G stereo) or suppression of 350 kHz video modulated beat frequency in the digitally-modulated NICAM subcarrier.

Intercarrier buzz fine tuning with 250 kHz square wave video modulation

The picture carrier for quadrature demodulation in the intercarrier mixer is not exactly 90 degrees due to the shift variation in the integrated phase shift network. The tuning of the LC reference circuit to provide optimal video suppression at the intercarrier output is not the same as that to provide optimal intercarrier buzz suppression. In order to optimize the AF signal performance, a fine tuning for the optimal S/N at the sound channel 2 (from 5.74 MHz) may be performed with a 250 kHz square wave video modulation.

Measurements at the demodulators

For all signal-to-noise measurements the generator must meet the following specifications:
phase modulation errors < 0.5° for B/W-jumps
intercarrier signal-to-noise ratio as measured with 'TV-demodulator AMF2' (weighted S/N) must be > 60 dB at 6 kHz sine wave modulation of the B/W-signal.
Signal-to-noise ratios are measured with $\Delta f = \pm 50$ kHz deviation and $f_{mod} = 1$ kHz; with a deviation of ±30 kHz the S/N ratio is deteriorated by 4.5 dB.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_P	supply voltage (pin 19)	–	8.8	V
V_I	voltage (pins 1, 6, 7, 13, 15, 17 and 20)	0	V_P	V
P_{tot}	total power dissipation	0	635	mW
T_{stg}	storage temperature	−25	+150	°C
T_{amb}	operating ambient temperature	0	+70	°C
V_{ESD}	electrostatic handling (note 1)			
	all pins except pins 1 and 20	±500	–	V
	pins 1 and 20	+400	–	V
		−500	–	V

Note to the Limiting Values

1. Equivalent to discharging a 200 pF capacitor through a 0 Ω series resistor.

CHARACTERISTICS

V_P = 5 V and T_{amb} = +25 °C; measurements taken in Fig.3 with f_{VC} = 38.9 MHz, f_{SC1} = 33.4 MHz and f_{SC2} = 33.158 MHz. Vision carrier (VC) modulated with different video signals, modulation depth 100% (proportional to 10% residual carrier).
Vision carrier amplitude (RMS value) $V_{i\,VC}$ = 10 mV; vision to sound carrier ratios are VC/SC1 = 13 dB and VC/SC2 = 20 dB. Sound carriers (SC1, SC2) modulated with f = 1 kHz and deviation Δf = 50 kHz, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_P	supply voltage (pin 19)		4.5	5	8.8	V
I_P	supply current (pin 19)		48	60	72	mA
IF amplifier (pins 1 and 20)						
R_I	input resistance		1.8	2.2	–	kΩ
C_I	input capacitance		–	2.0	2.6	pF
V_I	DC input voltage		–	1.75	–	V
$V_{i\,IF\,(RMS)}$	maximum input signal (RMS value, pins 1-20)	V_o = +1 dB	70	100	–	mV
	input signal sensitivity (RMS value)	–3 dB intercarrier signal reduction at pin 15	–	70	100	μV
ΔG_v	IF gain control		60	63	–	dB
V_2	voltage for gain control (pin 2)		1.7	–	2.6	V
B	IF bandwidth	–3 dB	50	70	–	MHz
Resonance amplifier (pins 10-11)						
$V_{o\,(p\text{-}p)}$	vision carrier amplitude (peak-to-peak value)	f_o = 38.9 MHz	–	270	–	mV
$R_{10\text{-}11}$	operating resistance		–	4	–	kΩ
L	inductance	Figs 3 and 4	–	0.247	–	μH
C	capacitance		–	68	–	pF
Q_L	Q-factor of resonant circuit	Q_o = 90	–	40	–	
$V_{10,\,11}$	DC voltage (pins 10 and 11)		–	V_P – 1	–	V
Intercarrier mixer output (pin 15)						
$V_{o\,(RMS)}$	output signal for 5.5 MHz (RMS value)		71	95	125	mV
	output signal for 5.74 MHz (RMS value)		32	43	56	mV
B	IF bandwidth	–1 dB	6	8.5	–	MHz
		–3 dB	7	10	–	MHz
V_{VID}/V_{15}	residual video AM on intercarrier	note 1	–	3	10	%
$V_{VC\,(RMS)}$	residual vision carrier (RMS value)	1st/2nd harmonic (38.9/77.8 MHz)	–	0.5	1	mV
R_{15}	output resistance (emitter follower)	1 mA emitter current	–	30	–	Ω
I_o	allowable AC output current (pin 15)		–	–	±0.7	mA
I_{15}	allowable DC output current		–	–	–2	mA
V_{15}	DC voltage	LC-circuit at pin 10, 11 adjusted to minimum video content at pin 15	1.5	1.75	2.0	V

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Limiting amplifiers (pins 13 and 17)						
$V_{i\,(RMS)}$	minimum input signal (RMS value)	−3 dB AF signal	−	300	450	μV
	maximum input signal (RMS value)		200	−	−	mV
$R_{13,17}$	input resistance		450	560	700	Ω
$V_{13,17}$	DC voltage		−	0	−	V
$V_{i\,(RMS)}$	level detector threshold for no muting (RMS value, pin 17)	only 5.74 MHz channel	0.8	1.2	1.7	mV
ΔV_i	hysteresis of level detector		4	7	12	dB
FM1 and FM2 demodulators Measurements with FM IF input signals of 5.5 MHz and 5.74 MHz with $V_{i\,IF\,(RMS)}$ = 10 mV (f_{mod} = 1 kHz, deviation Δf = ±50 kHz) at pins 13 and 17 without ceramic filters, R_S = 50 Ω. De-emphasis 50 μs. Q_L-factor = 11 for resonant circuits at pins 4-5 and 8-9 (including IC).						
$V_{IC\,(RMS)}$	intercarrier signals (RMS values, pins 4-5 and 8-9)		−	100	−	mV
V	DC voltage (pins 4, 5, 8 and 9)		−	1.8	−	V
$V_{o\,(RMS)}$	AF output signals (RMS values, pins 6 and 7)		0.84	0.95	1.07	V
ΔV_o	difference of AF signals between channels (pins 6 and 7)	note 2	−	−	1	dB
$R_{6,7}$	output resistance		75	100	130	Ω
$V_{6,7}$	DC voltage		1.8	2.1	2.4	V
$I_{6,7\,(M)}$	allowed AC current of emitter output (peak value)	note 3	−	−	±1.5	mA
$I_{6,7}$	maximum allowed DC output current		−	−	−2	mA
THD	total harmonic distortion		−	0.5	1.0	%
$V_{o\,(RMS)}$	AF output signal (RMS value)	THD = 1.5%	1.25	−	−	V
α_{AM}	AM suppression	1 kHz; m = 0.3	48	54	−	dB
S/N(W)	weighted signal-to-noise ratio	CCIR468-3	64	68	−	dB
B	AF bandwidth (−3 dB) lower limit upper limit		 − 100	 − −	 20 −	 Hz kHz
α_{CR}	crosstalk attenuation (pins 6-7)		60	70	−	dB
V_3	adjustment voltage for AF2	note 4 minimum output signal maximum output signal	 − −	 0 5	 − −	 V V
ΔG_{AF2min}	gain for minimum V_{out}	V_3 = 0 V	−1.5	−2.5	−	dB
ΔG_{AF2max}	gain for maximum V_{out}	V_3 = 5 V	1.0	1.5	−	dB
$V_{14,16}$	DC voltage (pins 14 and 16)		−	1.8	−	V
Tracking Automatic Frequency Control (AFC) of the vision carrier reference circuit						
$V_{o\,12}$	tracking output voltage (pin 12)	note 5	V_P − 3.3	−	V_P − 1	V
F_{TR}	tracking reducing factor for black picture white test picture 50% grey picture		 − − −	 9 4 6	 − − −	

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
S	AFC steepness (open loop) for					
	black picture		–	–8	–	mV/kHz
	white test picture		–	–3	–	mV/kHz
	50% grey picture		–	–5.5	–	mV/kHz
AF signal switches						
input signals: FM intercarrier into pin 13		see part FM demodulator				
no signal in pin 17 (AF2)						
the output signals are related to the signals described in the demodulator part.						
V_o/V_{omute}	AF2 mute attenuation (pin 6)		70	–	–	dB
dV_6	DC jump at the AF2 output	switching to Mute	–	5	25	mV
AF performance for FM operation (standard B/G)						
input signals: B/G IF input signal (pin 1, 20)						
unmodulated sound carriers						
different video modulation (100%)						
the output signals are related to the signals described in the demodulator part.						
(S+N)/N(W)	weighted signal-to-noise ratio	CCIR468-3; de-emphasis 50 µs				
	black picture	f_i = 5.5 MHz	59	63	–	dB
	2T/20T pulses with white bar	f_i = 5.5 MHz	57	61	–	dB
	6 kHz sine wave, B/W-modulated	f_i = 5.5 MHz	52	56	–	dB
	250 kHz square wave, B/W-modulated	f_i = 5.5 MHz	50	54	–	dB
	black picture	f_i = 5.742 MHz	57	61	–	dB
	2T/20T pulses with white bar	f_i = 5.742 MHz	55	59	–	dB
	6 kHz sine wave, B/W-modulated	f_i = 5.742 MHz	50	54	–	dB
	250 kHz square wave, B/W-modulated	f_i = 5.742 MHz	48	52	–	dB
Ripple rejection of the AF outputs						
RR	ripple rejection V_{ripple} on V_P / V_{ripple} on V_{out}	$V_{R(p-p)}$ = 200 mV; f_R = 70 Hz	30	40	–	dB

Notes to the characteristics

1. Spurious intercarrier AM: m = (A – B)/A (A = signal at sync; B = signal with 100% picture modulation).
2. AF signal can be adjusted by V_3.
3. For larger current: R_L > 2.2 kΩ (pin 6 or 7 to GND) in order to increase the bias current of the output emitter follower.
4. If not used, pin 3 should not be connected.
5. Automatic Frequency Control (AFC) of the vision carrier reference circuit (pins 10 and 11) for reducing spurious video signals in the stereo/dual sound modes. The factor of reducing F_{TR} at a deviation Δf_{VC} specifies the ratio of spurious signals with/without tracking function.

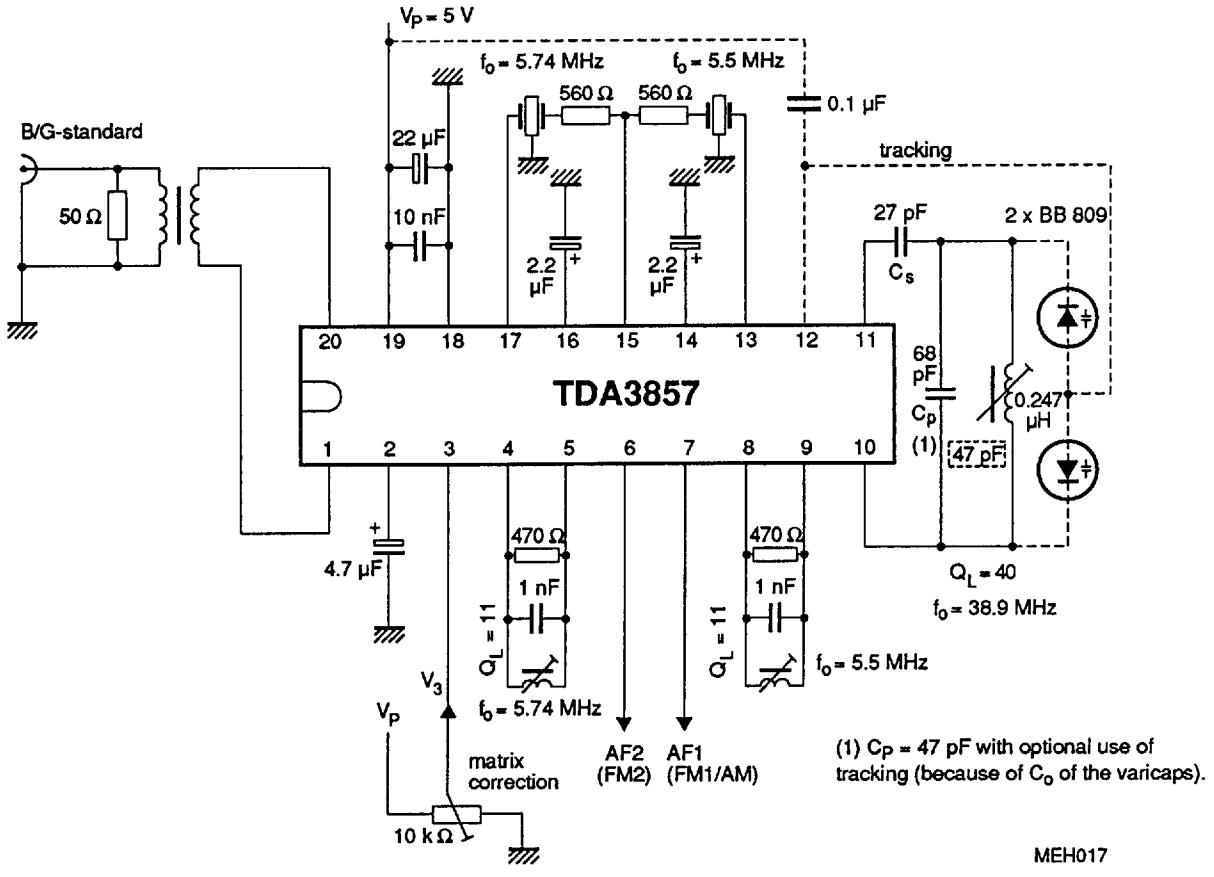
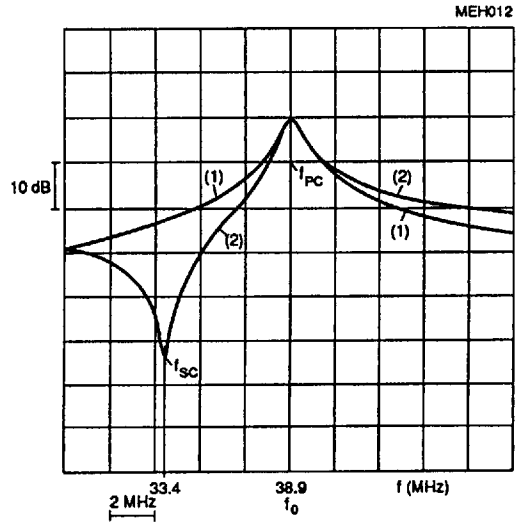


Fig.3 Test and application circuit for standard B/G (for application SAW-filters must be used).



(1) simple resonant circuit
(2) resonant circuit with C_P = 68 pF

$C_S = C_P (f_{VC}/f_{SC})^2 - C_P$
C_S = 27 pF (see Fig.3)

Fig.4 Frequency response of the 38.9 MHz reference circuit.

APPLICATION INFORMATION

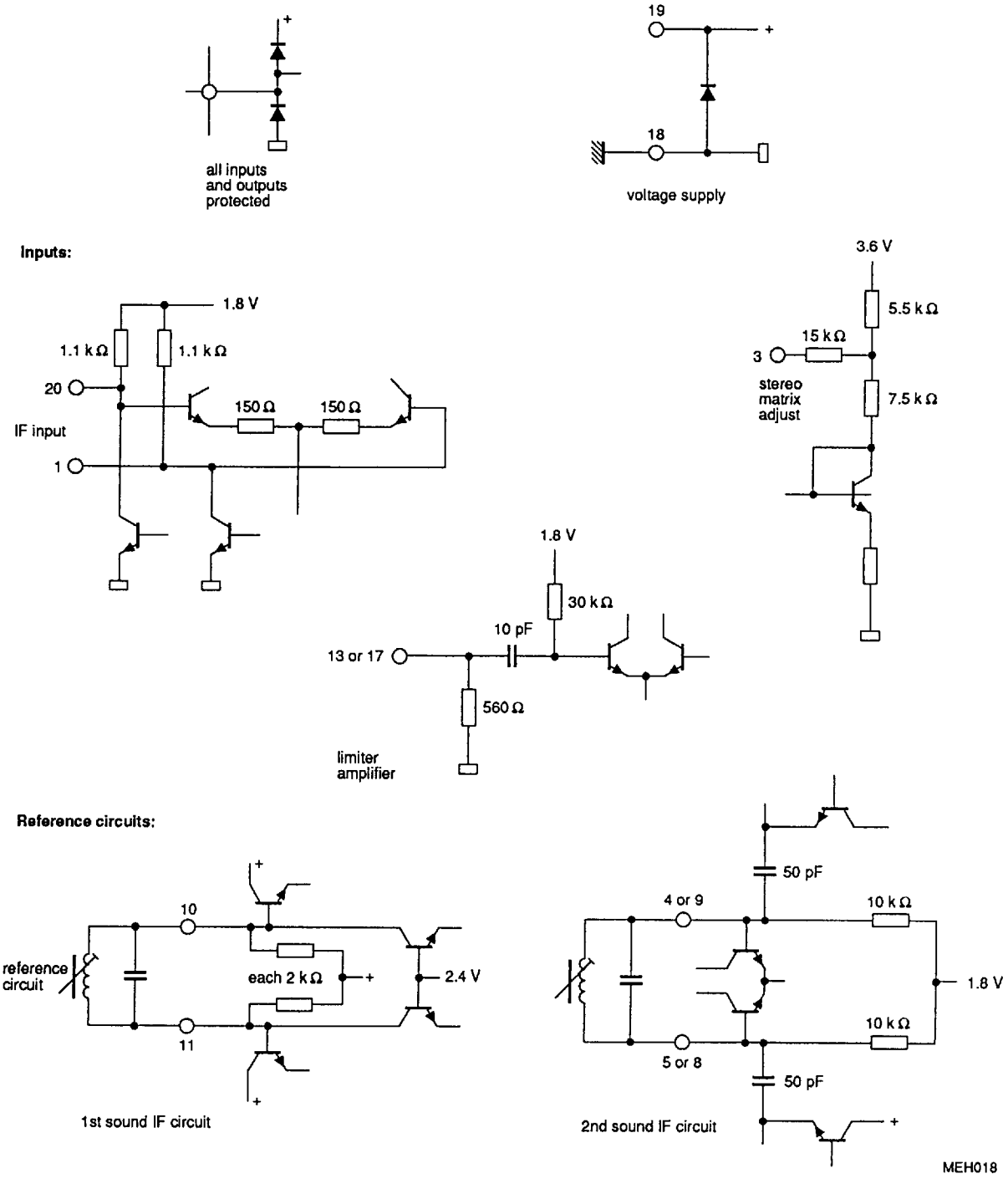


Fig.5 Internal circuits (continued in Fig.6).

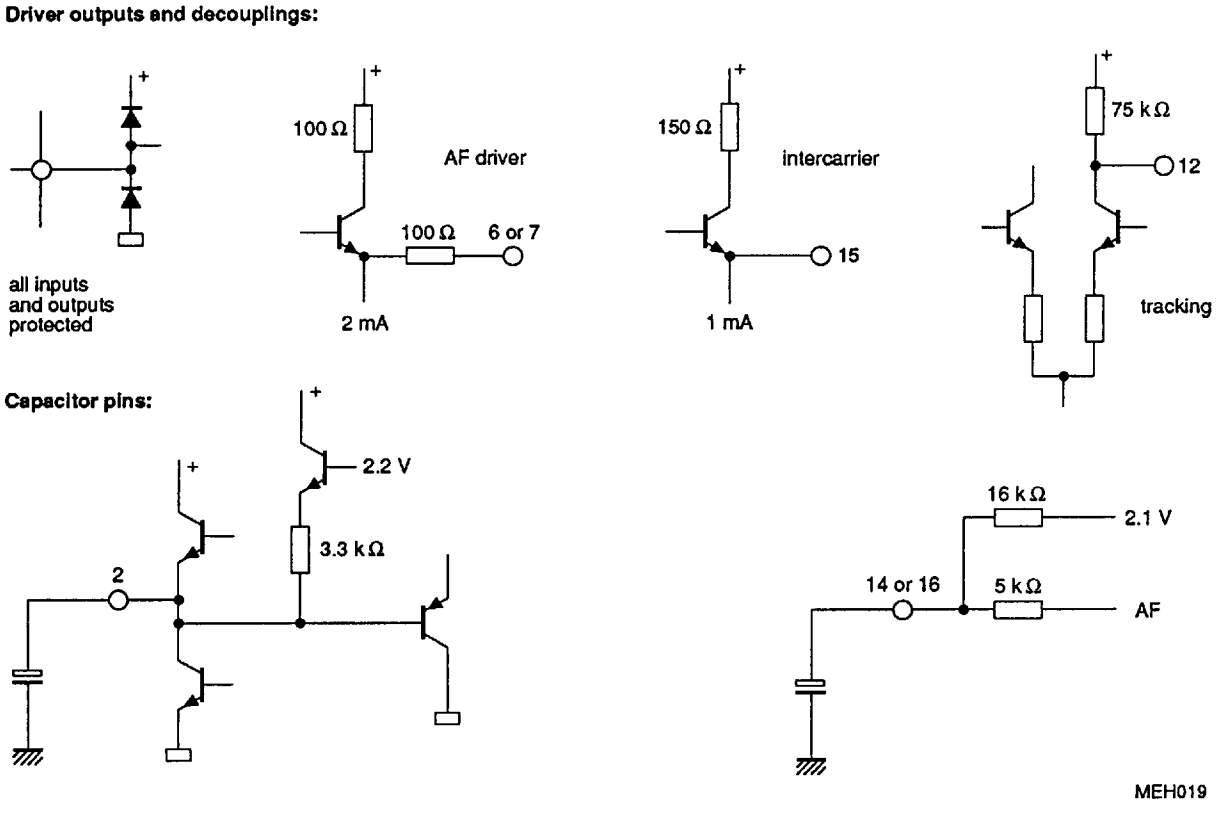
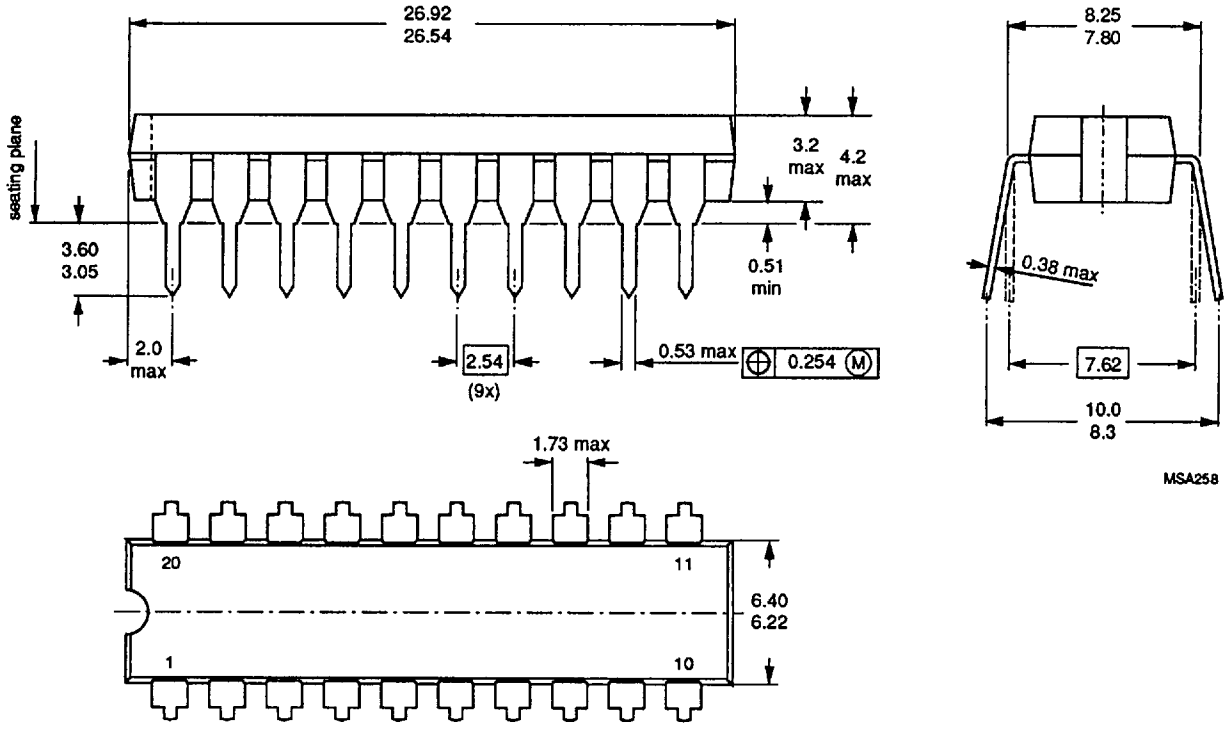


Fig.6 Internal circuits (continued from Fig.5).

PACKAGE OUTLINE



Dimensions in mm.

Fig.7 20-lead dual in-line; plastic (SOT146).

SOLDERING

Plastic dual in-line packages

BY DIP OR WAVE

The maximum permissible temperature of the solder is 260 °C; this temperature must not be in contact with the joint for more than 5 s. The total contact time of successive solder waves must not exceed 5 s.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed-circuit board has been preheated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply the soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C it must not be in contact for more than 10 s; if between 300 and 400 °C, for not more than 5 s.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

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